2SD2133

Silicon NPN epitaxial planar type

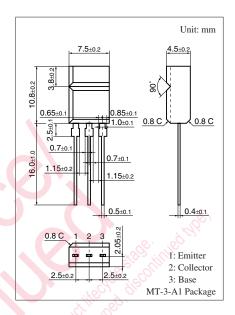
For low-frequency power amplification driver

■ Features

 \bullet Low collector-emitter saturation voltage $V_{\text{CE}(\text{sat})}$

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V _{CBO}	60	V	
Collector-emitter voltage (Base open)	V _{CEO}	50	V	
Emitter-base voltage (Collector open)	V_{EBO}	5	V	
Collector current	I_C	1	A	
Peak collector current	I_{CP}	1.5	A	
Collector power dissipation	P _C	1.5	W	
Junction temperature	T _j	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	



■ Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

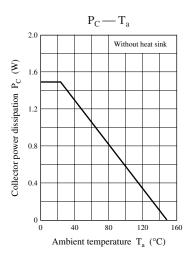
Symbol	Conditions	Min	Тур	Max	Unit
V _{CBO}	$I_C = 10 \mu\text{A}, I_E = 0$	60			V
V _{CEO}	$I_C = 2 \text{ mA}, I_B = 0$	50			V
V _{EBO}	$I_E = 10 \mu\text{A}, I_C = 0$	5			V
I_{CBO}	$V_{CB} = 20 \text{ V}, I_E = 0$			0.1	μΑ
h _{FE1} *1, 2	$V_{CE} = 10 \text{ V}, I_{C} = 0.5 \text{ A}$	85		340	_
h _{FE2} *1	$V_{CE} = 5 \text{ V}, I_{C} = 1 \text{ A}$	50	100		
h _{FE3}	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}$	35			
V _{CE(sat)}	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.2	0.4	V
V _{BE(sat)}	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.85	1.20	V
f_T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		11		pF
	$\begin{array}{c} V_{CBO} \\ V_{CEO} \\ V_{EBO} \\ I_{CBO} \\ h_{FE1} \ ^{*1, 2} \\ h_{FE2} \ ^{*1} \\ h_{FE3} \\ V_{CE(sat)} \\ V_{BE(sat)} \\ f_{T} \end{array}$	$\begin{array}{lll} V_{CBO} & I_C = 10 \ \mu A, \ I_E = 0 \\ \hline V_{CEO} & I_C = 2 \ mA, \ I_B = 0 \\ \hline V_{EBO} & I_E = 10 \ \mu A, \ I_C = 0 \\ \hline I_{CBO} & V_{CB} = 20 \ V, \ I_E = 0 \\ \hline h_{FE1} & ^{*1, 2} & V_{CE} = 10 \ V, \ I_C = 0.5 \ A \\ \hline h_{FE2} & ^{*1} & V_{CE} = 5 \ V, \ I_C = 1 \ A \\ \hline h_{FE3} & V_{CE} = 10 \ V, \ I_C = 1 \ mA \\ \hline V_{CE(sat)} & I_C = 500 \ mA, \ I_B = 50 \ mA \\ \hline V_{BE(sat)} & I_C = 500 \ mA, \ I_B = 50 \ mA \\ \hline f_T & V_{CB} = 10 \ V, \ I_E = -50 \ mA, \ f = 200 \ MHz \\ \hline \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

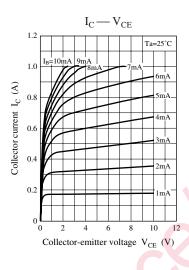
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

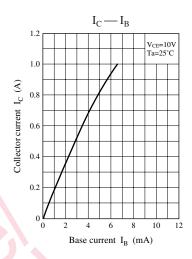
*2: Rank classification

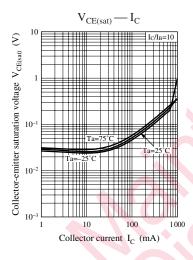
Rank	Q	R	S
h_{FE1}	85 to 170	120 to 240	170 to 340

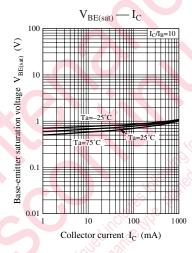
^{2. *1:} Pulse measurement

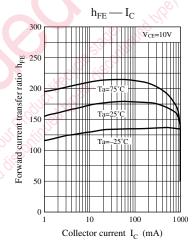


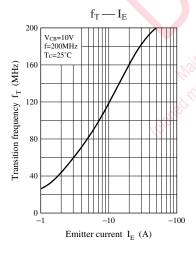


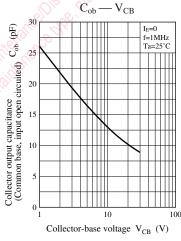


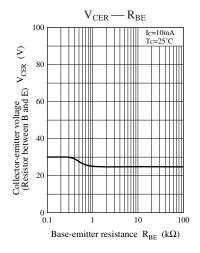


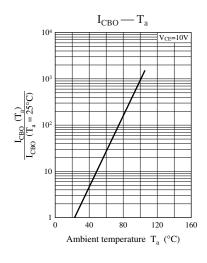


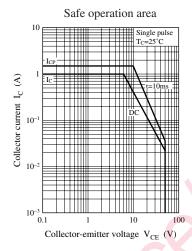


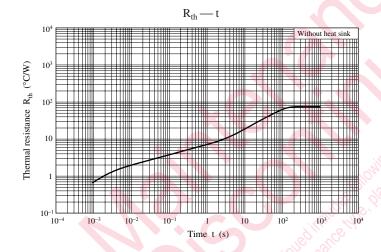












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